# **DULTRA MICRO DULTRA MICRO POWER SYSTEM** (2.00 mm) .0787" PITCH



### **FEATURES & BENEFITS**

- Board-to-board, cable-to-board and cable-to-cable
- Up to 18 A per blade (1 blade powered)

- Choice of 2 to 10 positions
- 5 mm to 20 mm stack heights; vertical and right-angle orientations
- Tin or 10  $\mu^{\rm "}$  Gold plated power blades; 30  $\mu^{\rm "}$  Gold plating available to meet specific regulations
- Optional weld tabs
- Mating cable assemblies with plastic top or metal side latching
- Severe Environment Testing qualified (UMPT/UMPS); aligns with MIL-DTL-55302. Visit samtec.com/set

### **KEY SPECIFICATIONS (UMPT/UMPS)**

#### **CURRENT RATING (PER CONTACT)**

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UMPT/UMPS							
PINS	-т	-L					
1	17.8 A	17.5 A					
2	15.5 A	16.3 A					
3	13.5 A	13.9 A					
4	12.9 A	13.2 A					
10	9.8 A	8.9 A					

Ratings are derated 20% with 30  $^{\circ}\mathrm{C}$  rise to maximum allowable temperature.

### **CREEPAGE & CLEARANCE**

UMPT/UMPS				
CREEPAGE	2.20 mm			
CLEARANCE	1.65 mm			

Selectively loading contacts achieves customer specific creepage and clearance requirements.

STACK HEIGHTS	INSULATOR MATERIAL	CONTACT MATERIAL	PLATING	OPERATING TEMP RANGE	VOLTAGE RATING	LEAD-FREE SOLDERABLE
5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16, 18, 20 mm	Black LCP	Copper Alloy	Sn or Au over 50 μ" (1.27 μm) Ni	-55 °C to +105 °C with Tin -55 °C to +125 °C with Gold	460 VAC/ 650 VDC	Yes

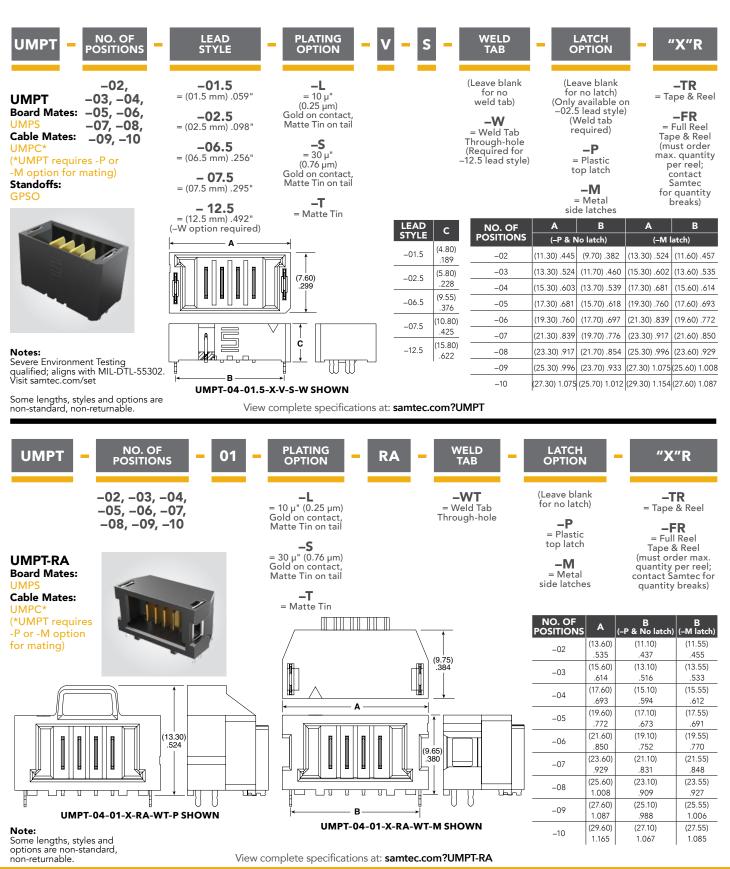
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#### Unless otherwise approved in writing by Samtec, all parts and components are designed and built according to Samtec's specifications which are subject to change without notice.

## **mPOWER**°

## **ULTRA MICRO POWER TERMINAL**



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